07/11/2017 504451716

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4498417

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
DAISUKE UENOSONO	06/27/2017
TAKASHI TSUKAMOTO	06/26/2017
SHOYA UEDA	06/27/2017
NAOTO SUGIE	06/26/2017
KOUTATSU SHIBAYAMA	06/26/2017

RECEIVING PARTY DATA

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City:	TOKYO
State/Country:	JAPAN
Postal Code:	108-8333

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15646754

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NAME OF SUBMITTER:	THOMAS HUNDLEY
SIGNATURE:	/Thomas Hundley/
DATE SIGNED: 07/11/2017	
	This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 4

PATENT REEL: 042977 FRAME: 0352

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PATENT REEL: 042977 FRAME: 0353

Docket No.: Only After Sept 16, 2012 Claiming Foreign Priority

ASSIGNMENT WITH DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63)

Whereas, I/We, the undersigned inventor(s) hereinafter called assignor(s), have invented certain improvements described in the application identified below; and

Whereas, YAZAKI CORPORATION of 4-28, Mita 1-chome, Minato-ku, Tokyo 108-8333 Japan, (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

(Legalization not required for recording but is prima facie evidence of execution under 35 USC 261)

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, including the right to claim priority under 35 USC 119, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

CONNECTOR

The above identified application was made or was authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the application for which this assignment with declaration is being submitted.

I am aware of the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR 1.56.

I hereby acknowledge that any willful false statement made in this assignment with declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

Authorization To Permit Access To Application by Participating Office

■ If checked, the undersigned hereby grants the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (JPO), the Korean Intellectual Property Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual property offices in which a foreign application claiming priority to the above-identified application is filed access to the above-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the applicant does not wish the EPO, JPO, KIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified application is filed to have access to the application.

In accordance with 37 CFR 1.14(h)(3), access will be provided to a copy of the application-as-filed with respect to: 1) the above-identified patent application-as-filed, 2) any foreign application to which the above-identified application claims priority under 35 USC 119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the above-identified patent application, and 3) any U.S. application-as-filed from which benefit is sought in the above-identified patent application.

In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit Access to Application by Participating Office.

PATENT REEL: 042977 FRAME: 0354

NAME OF SOLE OR FIRST INVENTOR:			
Given Name Daisuke (first and middle [if any])	Family Name or Surname UENOSONO		
Inventor's signature Daisuke UENOSONO Date June 27, 2017			
Residence: Kakegawa-shi, Shizuoka, Japan			
Mailing Address: c/o Yazaki Parts Co., Ltd., 653-2, Osaka, Kakeg	awa-shi, Shizuoka, Japan		
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Given Name Takashi (first and middle [if any])	Family Name or Surname TSUKAMOTO		
Inventor's signature Takashi Tsukamoto	Date June 26, 2017		
Residence: Kakegawa-shi, Shizuoka, Japan			
Mailing Address: c/o Yazaki Parts Co., Ltd., 653-2, Osaka, Kakeg	awa-shi, Shizuoka, Japan		
NAME OF THIRD INVENTOR:			
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Inventor's signature	Date		
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C/o System Circuit Tec Corporation, 6-13 Ekima	ae 1-chome, Fujieda-shi, Shizuoka, Japan		
NAME OF FOURTH INVENTOR:			
Given Name Naoto (first and middle [if any])	Family Name or Surname		
Inventor's signature Naoto SUGIE	Date June 26, 2017		
Kakegawa-shi, Shizuoka, Japan Residence:			
Mailing Address: c/o Yazaki Parts Co., Ltd., 653-2, Osaka, Kakegawa-shi, Shizuoka, Japan			
NAME OF FIFTH INVENTOR:			
Given Name (first and middle [if any]) Koutatsu	Family Name or Surname SHIBAYAMA		
Inventor's signature Kontatsu SHIBAYAMA	Date June 26, 2017		
Residence: Kakegawa-shi, Shizuoka, Japan			
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PATENT REEL: 042977 FRAME: 0355

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Docket No.:
Only After Sept 16, 2012
Claiming Foreign Priority

ASSIGNMENT WITH DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63)

Whereas, I/We, the undersigned inventor(s) hereinafter called assignor(s), have invented certain improvements described in the application identified below; and

Whereas, YAZAKI CORPORATION of 4-28, Mita 1-chome, Minato-ku, Tokyo 108-8333 Japan, (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged.

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, including the right to claim priority under 35 USC 119, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

(Legalization not required for recording but is prima facie evidence of execution under 35 USC 261)

As the below named inventor. I bereby declare that:

As the below harned inventor, I hereby	y decia	are that:	
This assignment with declaration is directed to:	•	The attached application, or	
		United States Application or PCT International Application Number	
The application is entitled:		filed on(Confirmation No).

CONNECTOR

The above identified application was made or was authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the application for which this assignment with declaration is being submitted.

I am aware of the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR 1.56.

I hereby acknowledge that any willful false statement made in this assignment with declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

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In accordance with 37 CFR 1.14(h)(3), access will be provided to a copy of the application-as-filed with respect to: 1) the above-identified patent application-as-filed, 2) any foreign application to which the above-identified application claims priority under 35 USC 119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the above-identified patent application, and 3) any U.S. application-as-filed from which benefit is sought in the above-identified patent application.

In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit Access to Application by Participating Office.

PATENT REEL: 042977 FRAME: 0356

NAME OF SOLE OR FIRST INVENTOR:			
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Given Name Shoya (first and middle [if any])	Family Name or Surname		
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Fujieda-shi, Shizuoka, Japan Residence:			
Mailing Address: c/o System Circuit Tec Corporation, 6-13 Ekima	ae 1-chome, Fujieda-shi, Shizuoka, Japan		
NAME OF FOURTH INVENTOR:			
Given Name Naoto (first and middle [if any])	SUGIE Family Name or Surname		
Inventor's signature	Date		
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Mailing Address: c/o Yazaki Parts Co., Ltd., 653-2, Osaka, Kakegawa-shi, Shizuoka, Japan			
NAME OF FIFTH INVENTOR:			
Given Name (first and middle [if any]) Koutatsu	Family Name or Surname SHIBAYAMA		
	·		
Inventor's signature	Date		
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PATENT REEL: 042977 FRAME: 0357

RECORDED: 07/11/2017